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NOTICE OF (See MIL-STD-44 This revision described below has been	REVISION (NOR) 80 for instructions) authorized for the document listed.	DATE (YYMMDD) 91/11/14	Form Approved OM8 No. 0704-0188
Public reporting burden for this colli instructions, searching existing data collection of information. Send commu information, including suggestions for Operations and Reports 1215 lefferso	ection is estimated to average 1 hour pe sources, gathering and maintaining the ents regarding this burden estimate or a r reducing this burden, to Washington He n Davis Highway, Suite 1204, Arlington, agement and Budget, Washington, DC 20503	any other aspect of this col adquarters Services, Directo VA 22202-4302, and to the O	lection of prate for Information
1. ORIGINATOR NAME AND ADDRESS		2. CAGE CODE	3. NOR NO.
efense Electronics Supply Center		67268	5962-R035-92
Dayton, Ohio 45444-5277		4. CAGE CODE	5. DOCUMENT NO.
		67268	5962-87713
. TITLE OF DOCUMENT		7. REVISION LETTER	
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DESC FORM 193

1. SCOPE

			for alacs P m	icrocircuit	te in accordance
1.1 <u>Scope</u> . This drawing describes devi with 1.2.1 of MIL-STD-883, "Provisions for non-JAN devices".	the use o	of MIL	-STD-883 in co	njunction w	with compliant
1.2 Part number. The complete part num	ber shall	be as	shown in the	following e	example:
5962-87713 01 Creating number Device (1.2.	- ./pe .1)	Ċ	Q I I ase outline (1.2.2)		X
1.2.1 Device_type. The device type sha	all identi	fy the	circuit funct	ion as fol	lows:
Device type Generic num	nber		<u>Circuit func</u>	tion	
01 8274		Multi	-protocol seri	al control	ler
1.2.2 <u>Case outline</u> . The case outline s follows:	shall be a	s desi	gnated in appe	ndix C of M	MIL-M-38510, and as
Outline letter			Case	outline	
Q	D-5	(40-le	ad, 9/16" x 2	1/16"), dua	al-in-line package
1.3 Absolute maximum ratings.					
Supply voltage Vcc Voltage on any pin with respect to g Storage temperature range	onds) e (θ _{JC}) -	 	65 C to 1.5 W 300°C See Mil- 200°C	M-38510, a∣	ppendix C
Supply voltage (V _{CC}))		0.5 V C	.5 V de le	dc
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2. APPLICABLE DOCUMENTS

2.1 <u>Government specification and standard</u>. Unless otherwise specified, the following specification and standard, of the issue listed in that issue of the Department of Defense Index of Specifications and Standards specified in the solicitation, form a part of this drawing to the extent specified herein.

SPECIFICATION

MILITARY

MIL-M-38510

Microcircuits, General Specification for.

STANDARD

MILITARY

MIL-STD-863 - Test Methods and Procedures (un Microelectronic).

(Copies of the specification and standard required by manufacturers in connection with specific recursion functions should be obtained from the contracting activity on as directed by the contracting activity.)

2.2 Order of precedence. In the event of a conflict between the text of this drawing and the references cited herein, the text of this drawing shall take precedence.

3. REQUIREMENTS

3.1 Item requirements. The individual item requirements shall be in accordance with 1.2.1 of MIL-STD-883, "Provisions for the use of MIL-STD-883 in conjunction with compliant non-JAN devices" and as specified herein.

3.2 Design, construction, and physical dimensions. The design, construction, and physical dimensions shall be as specified in MIL-M-38510 and herein.

3.2.1 Terminal connections. The terminal connections shall be as specified on figure 1.

3.2.2 Block diagram. The block diagram shall be as specified on figure 2.

3.2.3 Case outline. The case outline shall be in accordance with 1.2.2 herein.

3.3 Electrical performance characteristics. Unless otherwise specified, the electrical performance characteristics are as specified in table I and apply over the full recommended case operating temperature range.

3.4 Marking. Marking shall be in accordance with MIL-STD-883 (see 3.1 herein). The part shall be marked with the part number listed in 1.2 herein. In addition, the manufacturer's part number may also be marked as listed in 6.4 herein.

3.5 <u>Certificate of compliance</u>. A certificate of compliance shall be required from a manufacturer in order to be listed as an approved source of supply in 6.4. The certificate of compliance submitted to DESC-ECS prior to listing as an approved source of supply shall state that the manufacturer's product meets the requirements of MIL-STD-883 (see 3.1 herein) and the requirements herein.

3.6 <u>Certificate of conformance</u>. A certificate of conformance as required in MIL-STD-883 (see 3.1 herein) shall be provided with each lot of microcircuits delivered to this drawing.

3.7 Notification of change. Notification of change to DESC-ECS shall be required in accordance with MIL-SID-883 (see 3.1 herein).

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Test	Symbol	$-55^{\circ}C \leq TC \leq +125^{\circ}C$	Conditions Group A Limit $-55^{\circ}C \leq T_C \leq +125^{\circ}C$ subgroups $4.5 V \leq V_{CC} \leq 5.5 V$			
		4.5 V ≤ V _{CC} ≤ 5.5 V unless otherwise specified	1	 Min	Max	1
Input low voltage	VIL	1/	1, 2, 3	-0.5	0.8	v
Input high voltage	VIH	1/	1, 2, 3	2.2	VCC +0.5	V
Output low voltage	VOL	I _{OL} = 2.0 mA	1, 2, 3		0.45	V
Output high nollage	^V он	I _{0!!} 200 4A	1, 2, 3	2.1		V
Input leakage current	IIL	V _{IN} = V _{CC} (max) to 0 V (pin 10 is guaranteed but not tested)	1, 2, 3		±10	μA
Output float leakage current	IOFL	V _{OUT} = V _{CC} (max) to 4.5 V idata bus	1, 2, 3		±10	μA
V _{CC} supply current	ICC	V _{CC} = 5.5 V	1, 2, 3		240	mA
Input crpssitance	- IN	See 4.3.1c	Ċ,		10	₽Ē
Output capacitance	COUT	See 4.3.1c	4		15	l pF
Input/output capacitance	C1/0	See 4.3.1c	4		20	l pF
Functional tests		See 4.3.1d	7,8		1)
Clock period	tcy	2/	9,10,11	250	4000	ns
CLK low time	τcL	2/	9,10,11	105	2000	ns
CLK high time	^t сн	2/	9,10,11	105	2000	l ns
CLK rise time	tr	1/2/	9,10,11	0	30	ns
Clock fall time	tf	2/	9,10,11	0	30	ns
See footnotes at end of tal	ble.		-in,	<u></u>		
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Test	Symbol	Conditions -55°C \leq TC \leq +125°C 4.5 V \leq VCC \leq 5.5 V	 Group A subgroups	 Lim 	Unit	
		unless otherwise specified		Min	Max	i T
Ag, A1 setup to RD neg. edge	t _{AR}	2/	9,10,11	0		ns
A ₀ , A ₁ data output i delay	t _{AD}	C _L = 150 pF <u>2</u> /	9,10,11		200	ns
An, Al hold after RD neg. edge	t _{RA}	<u>2</u> /	9,10,11	070 07		l ns
RD neg. edge to data	t _{RD}	C _L = 150 pF <u>2</u> /	9,10,11		245	l ns
RS pulse width	¢RR	2/	9,10,11	250		ns
Output float delay	t _{DF}	<u>2</u> /	9,10,11		120	ns
CS, A _O , A ₁ setup to WR neg. edge	t _{AW}	2/	9,10,11			ns
CS, A ₀ , A ₁ hold after WR pos. edge	t _{WA}	2/	9,10,11			l ns
WR pulse width	tww	<u>2</u> /	9,10,11	320		l ns
Data setup to WR pos. edge	t _{DW}	<u>2</u> /	9,10,11		150	ns
Data hold after WR pos. edge	¢WD	2/	9,10,11	0		ns
TPT setup top INTA neg. edge	tpi	<u>2</u> /	9,10,11	0		i I ns
IPI hold after INTA pos. edge	tIP	<u>2</u> /	9,10,11	10		 ns
INTA pulse width	tII	<u>2</u> /	9,10,11	250		ns l
IPI neg. edge to IPC delay	tpIP0	2/	9,10,11		100	ns
INTA neg. edge to data output delay	tID	2/	9,10,11		245	ns
iee footnotes at end of tab	le.					
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TABLE	I. Electrical	performance c	haracteristics	s - Continue	d.		
Test	Symbol	-55°C < Tr	tions < +125℃	Group A subgroups	Limits		Unit
		4.5 V < VCC unless otherw	se specified		Min	Max	
RD or WR to DRQ neg. edge	tco		2/	9,10,11		150	ns
Recovery time between controls	t _{RV}	<u>i</u>	2/	9,10,11	300		ns
CS. Ag, A: to RDYg or RDYg delay	t _{CW}	3	2/	9,10,11		140	n-
Daua clock cycle	tDCY	2	2/	3,10,11	4.5		t _{CY}
Data clock low time	t _{DCL}	<u>i</u>	2/	9,10,11	180		ns
Data clock high time	t _{DCH}		2/	 9,10,11 	180		ns
TxC to TxD delay	t _{TD}	<u>2</u>	2/	9,10,11		300	ns
RxD setup to RxC pos. edge	t _{DS}	2	2/	 9,10,11 	0		ns
RxD hold after RxC pos. edge	t _{DH}	<u>2</u>	2/	9,10,11	140		ns
TxC to INT delay	t _{ITD}	<u>1</u> /	2/	9,10,11	4	6	tcy
RxC to INT delay	t _{IRD}	<u>1</u> /	2/	 9,10,11 	7	10	t _{CY}
CTS, CD, SYNDET low time	tpl	2	2	9,10,11	200		ns I
CTS, CD, SYNDET high time	tpH	2	2/	9,10,11	200		ns I
Ext. INT from CTS, CD, SYNDET	t _{IPD}	2	2/	9,10,11		500	ns
1/ Guaranteed if not tested 2/ AC test conditions (See Input high level: Vinput low level: Vinput low level: Vin Output voltage high: Output voltage low: Input rise/fall time: Timing measurements Output load = 100 pF	figure 3): H = 2.4 V = 0.45 V $V_{0H} = 2.0 V$ $V_{0L} = 0.8 V$ $S: t_r/t_f < 10.00$ are made at 2.00 including test) V for logic " t jig. SIZE	1" and 0.8 Y	1)". .87713		
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3.8 Verification and review. DESC, DESC's agent, and the acquiring activity retain the option to review the manufacturer's facility and applicable required documentation. Offshore documentation shall be made available onshore at the option of the reviewer.

4. QUALITY ASSURANCE PROVISIONS

4.1 Sampling and inspection. Sampling and inspection procedures shall be in accordance with section 4 of MIL-M-38510 to the extent specified in MIL-STD-883 (see 3.1 herein).

4.2 Screening. Screening shall be in accordance with method 5004 of MIL-STD-883, and shall be conducted on all devices prior to quality conformance inspection. The following additional criteria shall apply:

- a. Burn-in test (method 1015 of MIL-STD-883).
 - Test condition A, B, C or D using the circuit submitted with the certificate of compliance (see 3.5 herein).
 - (2) T_A = +125°C, minimum.
- b. Interim and final electrical test parameters shall be as specified in table II herein, except interim electrical parameter tests prior to burn-in are optional at the discretion of the manufacturer.

4.3 <u>Quality conformance inspection</u>. Quality conformance inspection shall be in accordance with method 5005 of ML-S D-883 including groups A, B, C, and D inspections. The following additional criteria shall apply.

4.3.1 Group A inspection.

- a. Tests shall be as specified in table II herein.
- b. Subgroups 5 and 6 in table I, method 5005 of MIL-STD-883 shall be omitted.
- c. Subgroup 4 (CIN, COUT and CI/O measurements) shall be measured only for the initial test and after process or design changes which may affect capacitance.
- d. Subgroups 7 and 8 tests shall verify the instruction set. The instruction set forms a part of the vendors test tape and shall be maintained and available from the approved sources of supply.
- 4.3.2 Groups C and D inspections.
 - a. End-point electrical parameters shall be as specified in table II herein.
 - b. Steady-state life test (method 1005 of MIL-STD-883) conditions:
 - (1) Test condition A, B, C, or D using the circuit submitted with the certificate of compliance.
 - (2) $T_A = +125^{\circ}C$, minimum.
 - (3) Test duration: 1,000 hours, except as permitted by appendix B of MIL-M-38510 and method 1005 of MIL-STD-883.

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MIL-STD-883 test requirements	Subgroups (per method 5005, table I)
Interim electrical parameters (method 5004)	
Final electrical test parameters (method 5004)	1*,2,3,7,8, 9,10,11
Group A test requirements (method 5005)	1,2,3,7,8, 9,10,11
Groups C and D end-point electrical parameters (method 5005)	2,8(hot),10
Additional electrical subgroups for group C periodic inspections	

TABLE II. Electrical test requirements.

* PDA applies to subgroup 1.

5. PACKAGING

5.1 Packaging requirements. The requirements for packaging shall be in accordance with MIL-M-38510.

6. NOTES

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6.1 Intended use. Microcircuits conforming to this drawing are intended for use when military specifications do not exist and qualified military devices that will perform the required function are not available for OEM application. When a military specification exists and the product covered by this drawing has been qualified for listing on OPL-38510, the device specified herein will be inactivated and will not be used for new design. The QPL-38510 product shall be the preferred item

6.2 Replaceability. Microcircuits covered by this drawing will replace the same generic device covered by a contractor-prepared specification or drawing.

6.3 Comments. Comments on this drawing should be directed to DESC-ECS, Dayton, Ohio 45444, or telephone 513-296-5375.

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Vendor CAGE 		, i i i i i i i i i i i i i i i i i i i	Vendor name <u>and address</u> Intel Corporation 5000 W. Williams Field Road Shandler, AZ 85224	4

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